

P0260AI

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
600V	4.6Ω @ $V_{GS} = 10V$	2A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	
Continuous Drain Current ²	I_D	2	A
		1.3	
Pulsed Drain Current ^{1, 2}	I_{DM}	7	
Avalanche Current ³	I_{AS}	2	
Avalanche Energy ³	E_{AS}	20	mJ
Power Dissipation	P_D	50	W
		20	
Operating Junction & Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$	2.5	62.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$			

¹Pulse width limited by maximum junction temperature.

²Limited only by maximum temperature allowed

³ $V_{DD} = 50V$, $L = 10mH$, starting $T_J = 25^\circ C$

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	600			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.5	3.1	4.5	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 30\text{V}$			± 100	nA
Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 600\text{V}, V_{\text{GS}} = 0\text{V}, T_C = 25^\circ\text{C}$			25	μA
		$V_{\text{DS}} = 600\text{V}, V_{\text{GS}} = 0\text{V}, T_C = 100^\circ\text{C}$			250	
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_D = 1\text{A}$		4	4.6	Ω
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 10\text{V}, I_D = 1\text{A}$		1		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$		315		pF
Output Capacitance	C_{oss}			46		
Reverse Transfer Capacitance	C_{rss}			11		
Total Gate Charge ²	Q_g	$V_{\text{DD}} = 480\text{V}, I_D = 2\text{A}, V_{\text{GS}} = 10\text{V}$		10		nC
Gate-Source Charge ²	Q_{gs}			2.3		
Gate-Drain Charge ²	Q_{gd}			4.4		
Turn-On Delay Time ²	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300\text{V}, I_D = 2\text{A}, R_G = 25\Omega$		14		nS
Rise Time ²	t_r			28		
Turn-Off Delay Time ²	$t_{\text{d}(\text{off})}$			29		
Fall Time ²	t_f			33		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current ³	I_S				2	A
Forward Voltage ¹	V_{SD}	$I_F = 2\text{A}, V_{\text{GS}} = 0\text{V}$			1.5	V
Reverse Recovery Time	t_{rr}	$I_F = 2\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		344		nS
Reverse Recovery Charge	Q_{rr}			1.4		μC

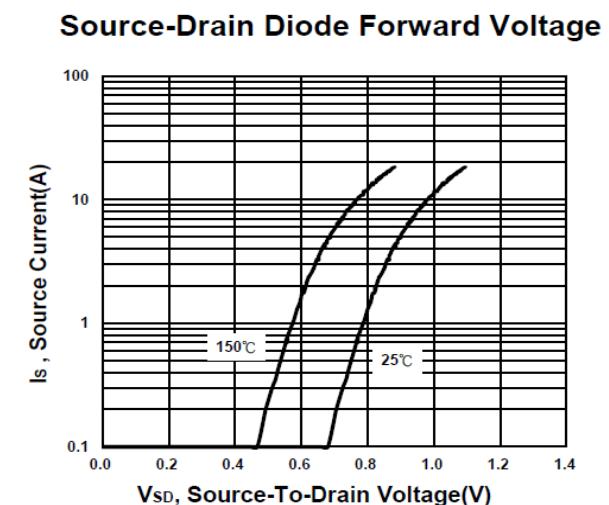
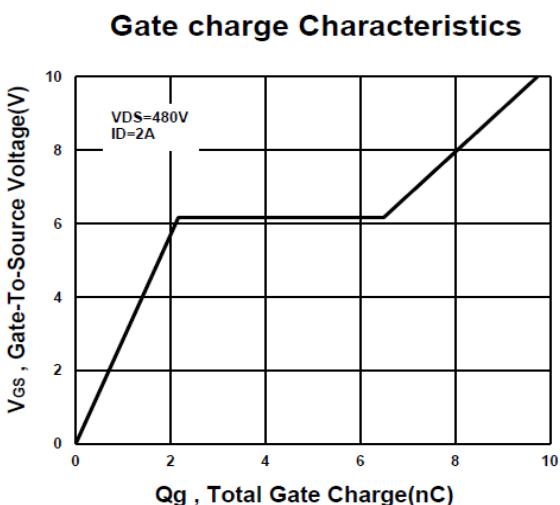
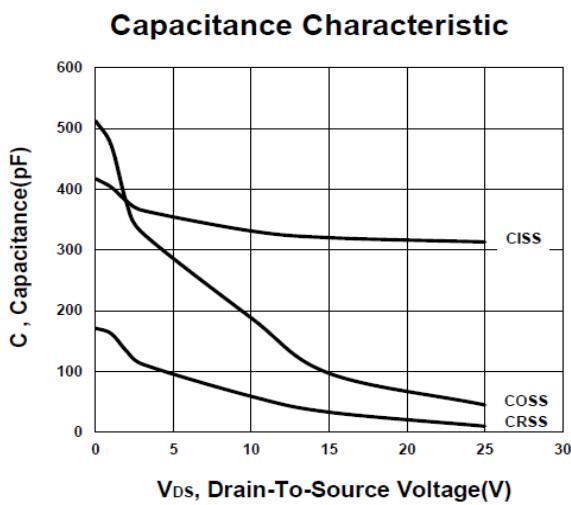
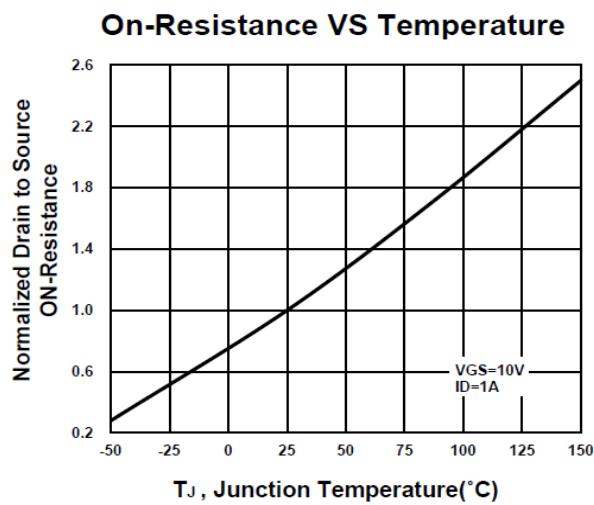
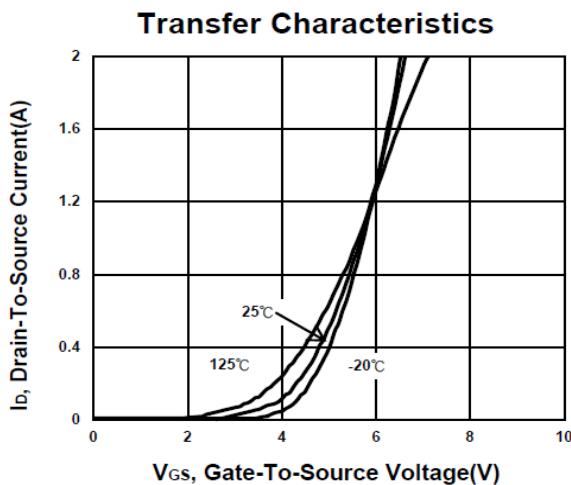
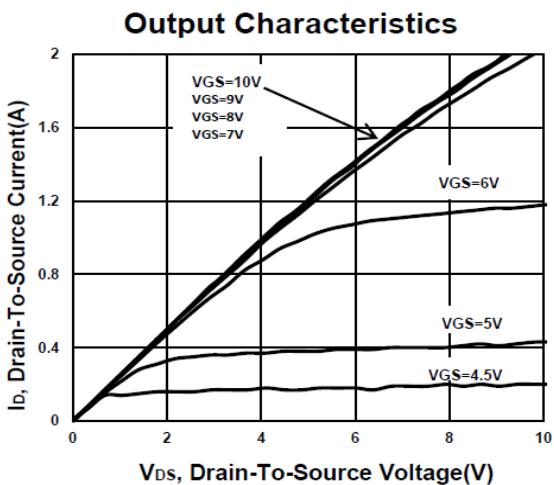
¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

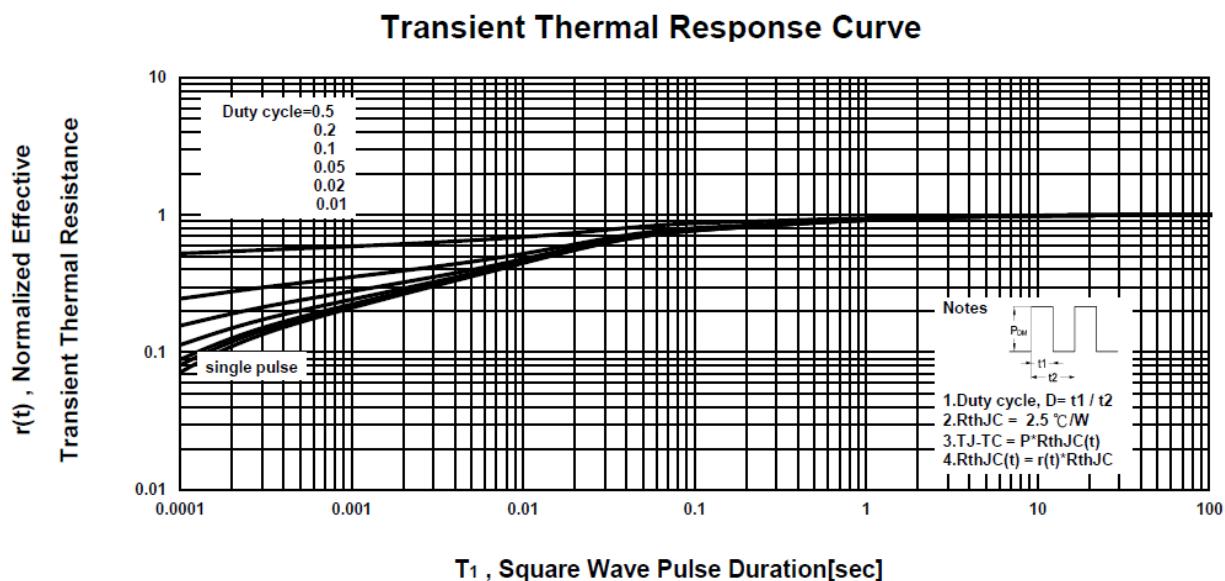
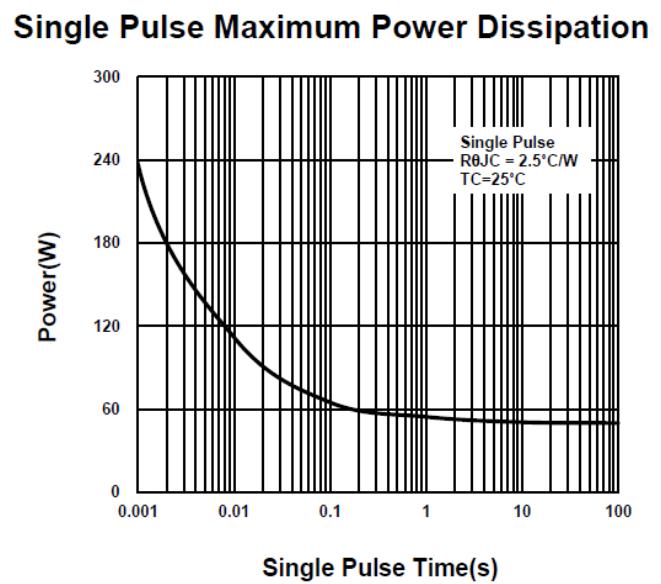
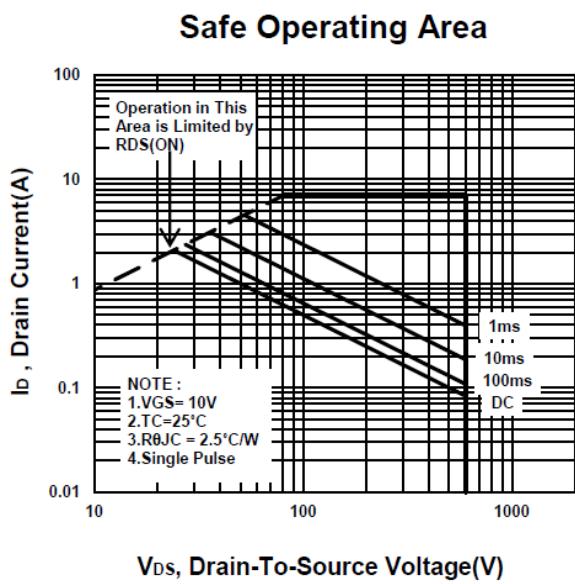
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P0260AI / P0260AD N-Channel Enhancement Mode MOSFET

Package Dimension

TO-251 MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	14	15	17.14	H	0.89		1.7
B	2.1	2.3	2.5	I	6.3		6.8
C	0.4	0.5	0.6	J	4.8		5.5
D	0.35	0.5	0.65	K	0.5	0.84	1.14
E	0.9	1.1	1.5	L	0.4	0.76	0.912
F	7		9.65	M		2.3	
G	5.3		6.22	N	1.4	2.16	2.23

